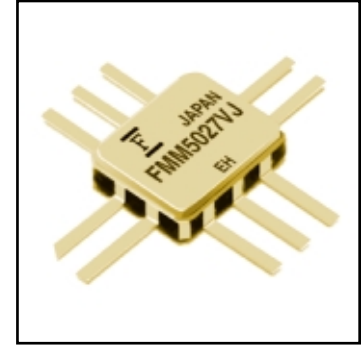


FEATURES

- Wide Frequency Band: 0.8 to 3GHz
- Medium Power: P1dB=26dBm (Typ.)@f=0.8 - 3GHz
- High Linear Gain: GL=19dB (Typ.)@ f=0.8 - 3GHz
- Wide Operating Temperature Range
- Hermetically Sealed Package

DESCRIPTION

The FMM5027VJ is a MMIC power amplifier that includes three amplifier stages designed for applications in the 0.8 to 3.0GHz frequency range. This product is uniquely suited for use in cellular, PCS/PCN, WLL base station amplifiers as it offers high gain, long term reliability and ease of use.



Fujitsu's stringent Quality Assurance Program assures the highest reliability and consistent performance.

ABSOLUTE MAXIMUM RATINGS (Ambient Temperature Ta=25°C)

Item	Symbol	Rating	Unit
DC Input Voltage	V _{DD1, 2}	10	V
DC Input Voltage	V _{GG1, 2}	-8	V
Input Power	P _{in}	15	dBm
Storage Temperature	T _{stg}	-55 to +150	°C
Operating Case Temperature	T _{op}	-40 to +85	°C

ELECTRICAL CHARACTERISTICS (Case Temperature Tc=25°C)

Item	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Frequency Range	f		0.8 - 3.0			GHz
Output Power at 1dB G.C.P.	P1dB	V _{DD1, 2} = 8V V _{GG1, 2} = -3V P _{in} = -5dBm	25.0	26.0	-	dBm
Linear Gain	GL		17.0	19.0	-	dB
Gain Flatness	ΔG		-	2.0	3.0	dB
Input VSWR	VSWR _i		-	2:1	-	-
DC Input Current	I _{DD}	V _{DD1, 2} = 8V V _{GG1, 2} = -3V	-	220	300	mA
DC Input Current	I _{GG}		-	2	4	mA

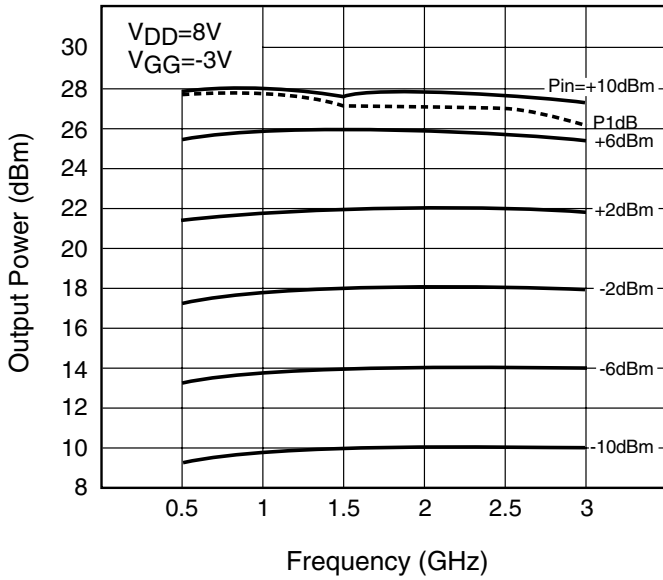
CASE STYLE: VJ

G.C.P.: Gain Compression Point

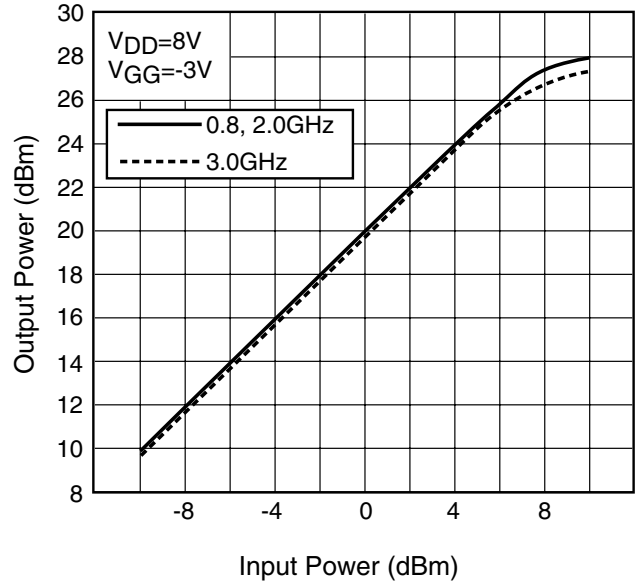
FMM5027VJ

MMIC Power Amplifier

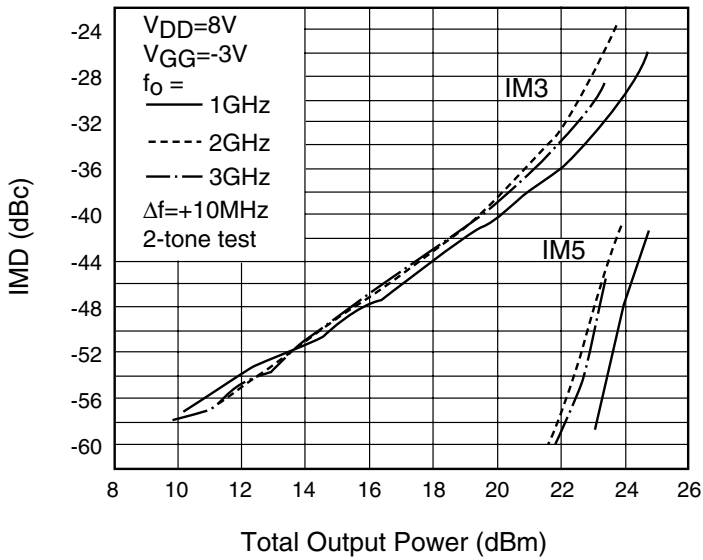
OUTPUT POWER vs. FREQUENCY



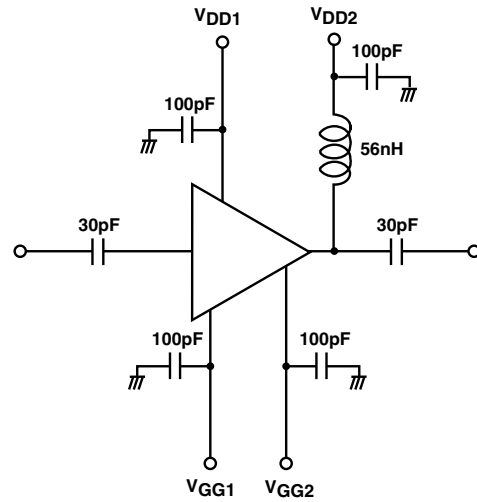
OUTPUT POWER vs. INPUT POWER



OUTPUT POWER vs. IMD

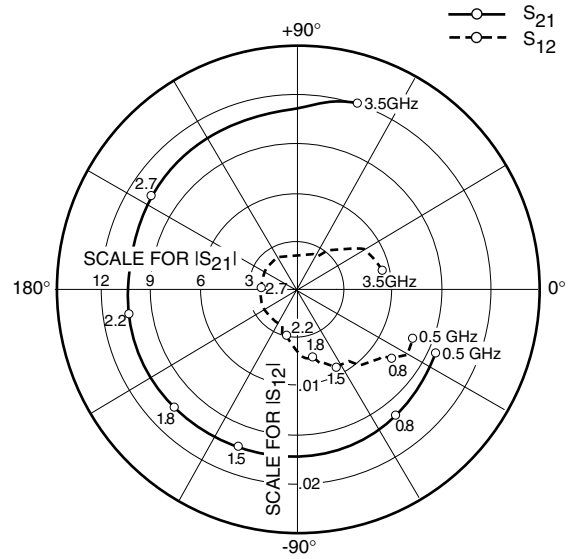
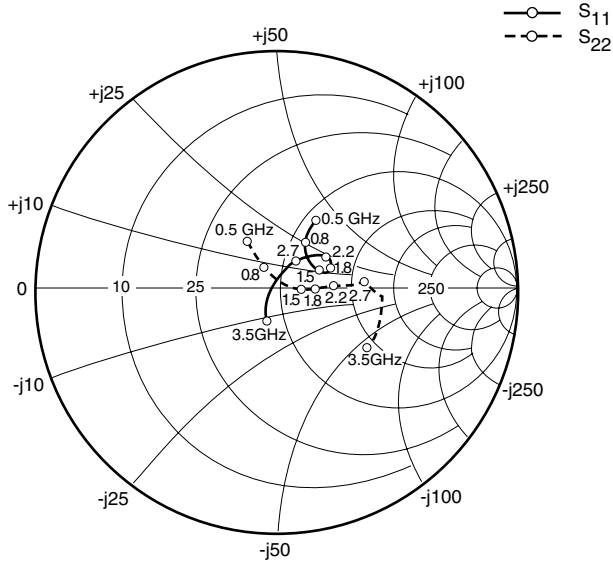


RECOMMENDED TEST CIRCUIT



FMM5027VJ

MMIC Power Amplifier



S-PARAMETERS

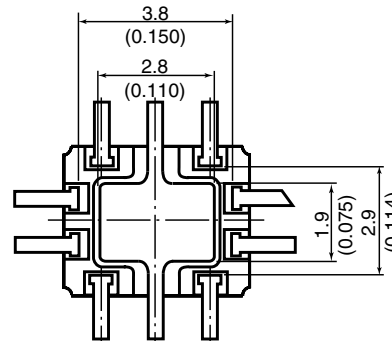
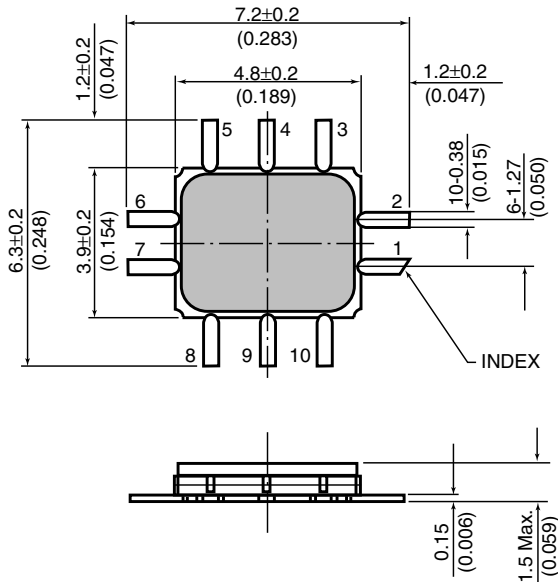
$V_{DS} = 8V, V_{GG} = -3V$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
500	.148	-103.6	9.376	-24.8	.013	-23.5	.226	122.4
600	.101	-114.3	9.563	-34.3	.013	-28.3	.171	121.0
700	.063	-126.9	9.702	-43.3	.013	-30.9	.131	119.5
800	.032	-161.2	9.857	-52.1	.012	-36.8	.099	117.3
900	.023	116.7	9.932	-61.0	.011	-38.2	.071	113.9
1000	.048	85.6	10.088	-69.5	.011	-40.1	.050	105.8
1100	.078	72.7	10.152	-77.9	.011	-40.4	.032	84.2
1200	.104	61.6	10.211	-86.4	.010	-50.9	.033	41.5
1300	.137	55.7	10.338	-94.7	.009	-55.7	.040	14.4
1400	.164	51.1	10.363	-103.3	.009	-54.4	.055	2.1
1500	.185	46.0	10.435	-111.5	.009	-63.4	.074	-3.2
1600	.208	40.7	10.462	-120.1	.008	-71.1	.099	-4.8
1700	.229	36.2	10.538	-128.5	.008	-72.7	.114	-3.9
1800	.236	32.5	10.578	-137.2	.008	-70.6	.136	-4.5
1900	.242	29.1	10.590	-145.9	.007	-77.6	.162	-2.7
2000	.246	25.2	10.632	-154.5	.007	-85.0	.190	-1.2
2100	.243	23.0	10.620	-163.2	.006	-93.8	.208	0.4
2200	.237	20.8	10.630	-171.8	.005	-106.5	.236	1.4
2300	.229	18.7	10.549	179.3	.005	-109.2	.263	1.7
2400	.204	19.5	10.604	170.9	.004	-114.5	.285	1.9
2500	.195	23.1	10.770	165.0	.004	-131.2	.320	2.8
2600	.188	26.9	10.787	156.4	.004	-147.2	.344	4.2
2700	.178	31.3	10.788	147.8	.004	178.5	.362	4.2
2800	.171	36.2	10.709	138.3	.004	157.2	.374	1.4
2900	.179	43.6	10.693	129.1	.004	144.7	.398	-1.1
3000	.186	51.1	11.044	118.9	.004	122.5	.432	-4.7
3100	.201	55.1	11.137	111.0	.004	66.5	.433	-6.2
3200	.244	56.5	11.133	101.6	.004	59.3	.440	-10.2
3300	.261	59.2	11.222	91.1	.005	52.6	.445	-16.5
3400	.295	59.7	11.881	81.4	.008	31.8	.454	-23.4
3500	.324	60.0	12.079	72.4	.009	12.2	.447	-34.1

FMM5027VJ

MMIC Power Amplifier

Case Style VJ



LEAD ASSIGNMENT

Lead	Symbol	Lead	Symbol
1.	RF in	6.	RF out/VDD2
2.	NC	7.	NC
3.	VGG1	8.	VDD1
4.	GND	9.	GND
5.	VGG2	10.	NC

Unit: mm(inches)

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- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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